

PRODUCT / PROCESS CHANGE NOTIFICATION PCN-000809

Date: MAY-04-2022 P1/4

Semtech Corporation, 200 Flynn Road, Camarillo CA 93012						
		nge Details				
Part Number(s) Affect	ed:	Customer Part Number(s)	Affected: ⊠ N/A			
Please see the next page for numbers.	or a list of affected part					
Description, Purpose	and Effect of Chang	je:				
Chipbond, Semtech's supplier, is moving its current machines to a clean room expansion area adjacent to the current clean room area via a connector bridge. The clean room areas have their own central air conditioning, electricity, vacuum pump, and ESD ground, but the control specifications are the same and third-party certified.						
The change will result in more efficient use of clean room facilities and will pave the way for future capacity expansion.						
As shown in the figure below	, the impacted processes	s have been highlighted with a red	box.			
Backside Grinding Laser Marking Mou Pick and Place (TinR) Change Classification		Clean Room expansion area (SB area) Current clean Room area (A area)			
Impact to Data Sheet	☐ Yes ☐ No	Function New Revision or Date	□ 195 □.It6			
			□ IV/A			
Impact to Performance	•	_				
		rformance, characteristics, or relia				
Implementation Date	AUG-04-2022	Work Week	32			
Last Time Ship (LTS) Of unchanged product	N/A	Affecting Lot No. / Serial No. (SN)	N/A			
Sample Availability	MAY-04-2022	Qualification Report Availability	N/A			
Supporting Document	s for Change Va <mark>lida</mark>	tion/Attachments:				
N/A						



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Issuing Authority					
Semtech Business Unit:	Signal Integrity Product Group (SI	IP)			
Semtech Contact Info:	Pedro Jr. Bernas pbernas@semtech.com (289) 856-9326 x1162	9			
FOR FURTHER INFORMATION & WO	PRLDWIDE SALES COVERAGE: http://www.semt	ech.com/contact/index.html#support			

• Part Number(s) Affected

1	GN2104SC-IBTE3D	7	SC21150ACSTRT	10	SX9210ICSTRT
2	GN2104S-IBTE3D	8	SC33020HCSTRT	11	SX9320ICSTRT
3	GN2139C-IBTE3D	9	SC725CSTRT	12	SX9322ICSTRT
4	GN24L60-CSP-TR			13	SX9323ICSTRT
5	GN24L61-CSP-TR			14	SX9324ICSTRT
6	GN2904S-IBTE3D			15	SX9325ICSTRT
				16	SX9328ICSTRT
				17	SX9330ICSTRT
				18	SX9370ICSTRT

Qualification Report

o Pick and Place (TnR)

Machine Information

	Mühlbauer DS-15000	Mühlbauer DS-20000
Machine		
Die size range	0.5*0.5→7*7mm	0.5*0.5→7*7mm
Wafer size	6/8/12 inch	6/8/12 inch
Sprint UPH	About 12k	About 18k
Placement precision	X/Y Coordinate: ±30um, Theta:2°	X/Y Coordinate : ±30um, Theta : 2°
Sealing Tape Force	Max.=100N	Max.=100N
Sealing Shoe Temperature	Room temperature to 220°C	Room temperature to 220°C
Sealing Shoe Temperature Precision	Target ±5 °C	Target ±5 °C
IR capability	No	No



PRODUCT / PROCESS CHANGE NOTIFICATION PCN-000809

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- ESD Check Item
 - ✓ Surface Voltage , Spec. <±100V
 - ✓ Ionization discharge time , Spec. (±1000V ±100V : <5sec)
 - ✓ Balanced Voltage, Spec. ≤ ±35V for 30-60sec.
 ✓ Machine Grounding, Spec. <1 ohm



	光復廠TNR DS機台靜電壓、離	子消散設備月量測記錄表					
设備編引	攬(Equipment): TRDS2054F						
+劃日期	明(Plan Date): 2022.01.24						
a 動行F	期(Action Date): 2022.01.24						
J 17 4 1 3 1	Total Bately Edelion Editor		下限	上限			
No.	保養項目 Check Item	説明 (Content)	lower Spec		Result	Judgemen	
	NO.1表面靜電壓	< ±100V.2.5公分内	lower spec	оррег эрес	ricsuit	Judgemen	
1	Number 1 Surface Voltage	<±100V,within 2.5cm	>=-100	<=100	3 V	Pass	
	NO.2表面靜電壓	< ±100V,Within 2.5cm					
2	Number 2 Surface Voltage	<±100V,within 2.5cm	>=-100	<=100	4 V	Pass	
	針尖清潔	使用棉花棒清潔					
3	146 EURO EURO				ОК	Pass	
-	Cleaning tip	Use a cotton swab clean		and the same of th			
	A點+消散時間	實際使用與產品距離檢測,離子消				/=ureset	
4	A point Ionization +Discharge time	It must to be measured by actual	>0	<5	0.1 Sec	Pass	
	A點-消散時間	實際使用與產品距離檢測。離子消					
		散時間 (+1000v~+100v): <5sec	>0	<5	0.2 Sec	Pass	
5	A point Ionization -Discharge time	It must to be measured by actual					
		product distance ,Discharge time (±					
	A點平衡電壓值	1000v~±100v): <5sec 離子平衡電壓: <=+/-35V.維持					
6			>=-35	<=35	12 V	Pass	
O	A point Ionization Balanced voltage value	Balance voltage : <=+/-35V,For 30~60sec					
	B點+消散時間	實際使用與產品距離檢測。離子消					
7	B point ionization +Discharge time	数時間 (+1000v~+100v) · <5sec	>0	<5	0.3 sec	Pass	
	B point ionization +Discharge time	It must to be measured by actual product distance ,Discharge time (±					
	B點-消散時間	實際使用與產品距離檢測,離子消					
8	B point Ionization -Discharge time	散時間 (±1000v~±100v) : <5sec It must to be measured by actual	1 50	>0	<5	0.6 Sec	Pass
0	B point ionization -Discharge time	product distance Discharge time (±	~	20 43	0.0 sec	Pass	
		1000v~±100v): <5sec					
	B點平衡電壓值	離子平衡電壓: <=+/-35V,維持 30~60秒					
9	B point Ionization Balanced voltage	Balance voltage : <=+/-35V,For	>=-35	<=35	8 V	Pass	
	value C點+消散時間	30~60sec					
	C洲山+>约页以时(时)	實際使用與產品距離檢測,離子消 散時間(±1000v~±100v): <5sec		>0 <5			
10	C point Ionization +Discharge time	It must to be measured by actual	>0		1.2 sec	Pass	
	ACTION OF THE PROPERTY OF THE	product distance ,Discharge time (± 1000v~±100v) : <5sec			500,000,000		
	C點-消散時間	實際使用與產品距離檢測,離子消					
		敗時間 (±1000v~±100v): <5sec	>0 <5	>0 <5 1.4 sec		10.1710.000	
11	C point Ionization -Discharge time	It must to be measured by actual product distance .Discharge time (±			Pass		
		1000v~±100v) : <5sec					
	C點平衡電壓值	離子平衡電型: <=+/-35V,維持 30~60秒					
12	C point Ionization Balanced voltage value	Balance voltage : <=+/-35V,For 30~60sec	>=-35	<=35	18 V	Pass	
M Remark							
\$ 47 4 5 : 110)	H.	顕核者: 林樂諭					

項目	保養項目	說明	下限	上限	單位	執行OK?/結果
1	設備接地 (A-G)	接地電阻小於1歐姆	>0	-1	ohm(Ω)	0.3
1	Equitment Grounding	Grounding <1 ohm	70	1	OHITI(12)	0.5

Qualification Run

Device types (Die size)	1.115*1.571 mm	0.765*0.9mm
Wafer size	8"	8"
Bump Height	65	65
Die size (x)	1.115mm	0.765mm
Die size (y)	1.571mm	0.9mm
Die size (z)	0.29mm	0.29mm
Pocket size (x)	1.19mm	0.85mm
Pocket size (y)	1.64mm	1.03mm
Pocket size (z)	0.39mm	0.36mm
Carrier tape part No.	3M124391	3M114391
Carrier tape width	9.00	
Cover tape part No.	CP25-054A	CP25-054A
Cover tape width	5.40mm	5.40mm

TnR Dummy Qualification: PASS

1.115*1.571 mm Dummy Qualification, TnR Yield=99.93%

Machine No.	IN	OUT	Yield
TRDS2054	20010	20000	99.95%

0.765*0.9mm Dummy Qualification, TnR Yield=99.88%

Machine No.	IN	OUT	Yield
TRDS2054	30018	30000	99.94%



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Date: MAY-04-2022 P4/4

Visual Inspection / Visual Check (VC)

- **ESD Check Item**
 - Surface Voltage, Spec. <±100V
 - ✓ Ionization discharge time , Spec. (±1000V ±100V : <5sec)
 ✓ Balanced Voltage, Spec. ≤ ±35V for 30-60sec.

 - ✓ Machine Grounding, Spec. <1 ohm
 </p>

○借編	能(Equipment): TRFVI349F						y ⊂ ₩!			
	期(Action Date): 2022/01/21				CH					
M 1T E A	gg(Action Date): 2022/01/21		下限	上限	_					
No.	保養項目 Check Item	説明 (Content)	lower Spec		: R∈	sult	Judgemen			
-	NO.1表面靜電壓	< ±100V,2.5公分內								
1	Number 1 Surface Voltage	< ±100V, within 2.5cm	>=-100	<=100	1 V	1 V	Pass			
_	NO.2表面靜電壓	< ±100V,2.5公分內		<=100	2 V		Pass			
2	Number 2 Surface Voltage	< ±100V,within 2.5cm	>=-100	<=100	1 '	2 0	Pass			
3	NO.3表面靜電壓	< ±100V,2.5公分內	>=-100	<=100	Τ.	2 V	Pass			
3	Number 3 Surface Voltage	< ±100V,within 2.5cm	>=-100	<=100	'	2 0	Pass			
	針尖清潔	使用棉花棒清潔	- martine market and all the second and all the sec			ок	Pass			
4	Cleaning tip	Use a cotton swab clean	and the same of th	And the same of th	- 1	DK	Pass			
	A點+消散時間	實際使用與產品距離檢測,離子 消散時間 (±1000v~±100v):								
5	A point Ionization +Discharge time	It must to be measured by actual product distance ,Discharge time (±1000v~±100v)	>0	<5	1 Sec		Pass			
_	A點-消散時間	實際使用與產品距離檢測,離子 消散時間 (±1000v~±100v):	-		1		Pass			
6	time	It must to be measured by actual product distance	>0	<5	1.2 Sec		Pass			
7	A點平衡電壓值	離子平衡電壓: <=+/-35V,維持 30~60秒 Balance voltage: <=+/-35V.For	>=-35	<=35		2 V	Pass			
	A point Ionization Balanced voltage value B點+消費時期	Balance voltage:<=+/-35V,For 30~60sec 實際使用與產品距離檢測,離子								
		消散時間 (±1000v~±100v): <5sec			1.6 Sec		Pass			
8	B point Ionization +Discharge time	It must to be measured by actual product distance ,Discharge time (±1000v~±100v) : <5sec	>0	<5						
	B點-消散時間	實際使用與產品距離檢測,離子 消散時間 (±1000v~±100v): <5sec								
9	time	It must to be measured by actual product distance ,Discharge time (±1000v~±100v) : <5sec	>0	<5	<5 1.5 Sec		Pass			
10	B點平衡電壓值	離子平衡電壓:<=+/-35V,維持 30~60秒	>=-35	<=35	-1 V		Pass			
	B point Ionization Balanced voltage value	Balance voltage : <=+/-35V,For 30~60sec								
M Rem l行者:		要核者: 林秉滄	-	-	+					
	卡巴 影電子化表單	物(1火7回・作 本)店			W098	W111-0	04 V2			
1	保養項目		説明	下限	上限	單位	執行OK?/ś			

Grounding <1 ohm



Qualification Run

Equitment Grounding

Device types (Die size)	0.698*0.958mm	1.08*2.35mm
Wafer size	8"	12"
Bump Height	10 um	47.5 um
Die size (x)	0.698mm	1.08 mm
Die size (y)	0.958mm	2.35 mm
Die size (z)	0.185mm	0.1675 mm
Pocket size (x)	0.8mm	1.22 mm
Pocket size (y)	1.06mm	2.47 mm
Pocket size (z)	0.26mm	0.29 mm
Carrier tape part No.	3M154711-NB	3M137381
Carrier tape width	8mm	8mm
Cover tape part No.	CP25-054A CP25-054A	
Cover tape width	5.4mm	5.4mm

VC Dummy Qualification: PASS

ohm(Ω)

0.698*0.958mm Dummy Qualification, VC Yield=100%

Machine No.	IN	OUT	Yield
TRFVI348F (KF II)	40000	40000	100%

1.08*2.35mm Dummy Qualification, VC Yield=100%

Machine No.	IN	OUT	Yield
TRFVI348F (KF II)	40000	40000	100%